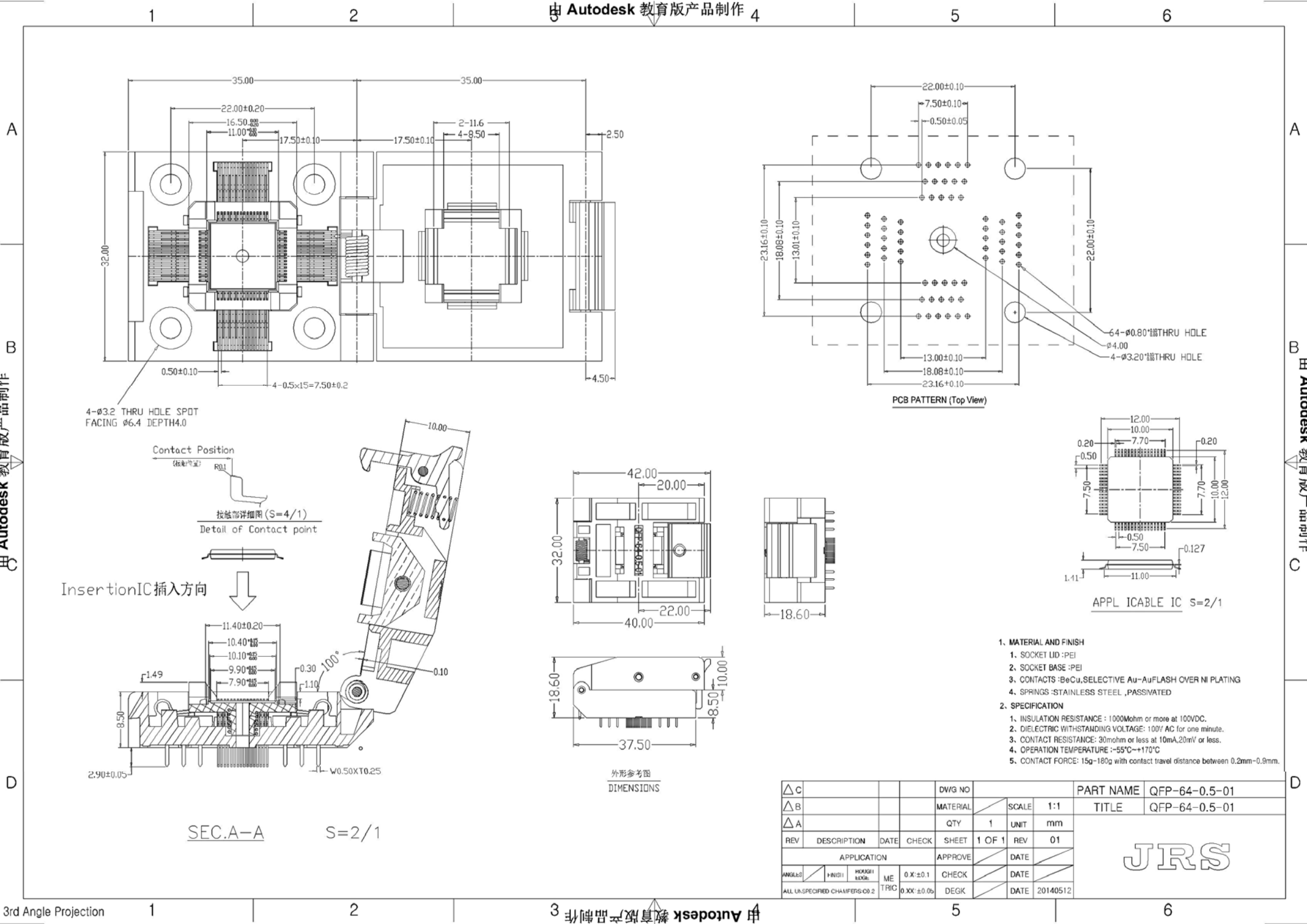




4-Ø3.2 THRU HOLE SPOT FACING Ø6.4 DEPTH4.0

InsertionIC插入方向

SEC.A-A

S=2/1

外形参考图  
DIMENSIONS

PCB PATTERN (Top View)

APPL ICABLE IC S=2/1

1. MATERIAL AND FINISH

1. SOCKET LID :PEI
2. SOCKET BASE :PEI
3. CONTACTS :BeCu,SELECTIVE Au-AuFLASH OVER NI PLATING
4. SPRINGS :STAINLESS STEEL ,PASSIVATED

2. SPECIFICATION

1. INSULATION RESISTANCE : 1000Mohm or more at 100VDC.
2. DIELECTRIC WITHSTANDING VOLTAGE: 100V AC for one minute.
3. CONTACT RESISTANCE: 30mohm or less at 10mA,20mV or less.
4. OPERATION TEMPERATURE :-55°C~+170°C
5. CONTACT FORCE: 15g~180g with contact travel distance between 0.2mm~0.9mm.

|                              |             |            |       |          |          |           |               |
|------------------------------|-------------|------------|-------|----------|----------|-----------|---------------|
| △ C                          |             |            |       | DWG NO   |          | PART NAME | QFP-64-0.5-01 |
| △ B                          |             |            |       | MATERIAL | SCALE    | 1:1       | TITLE         |
| △ A                          |             |            |       | QTY      | 1        | UNIT      | mm            |
| REV                          | DESCRIPTION | DATE       | CHECK | SHEET    | 1 OF 1   | REV       | 01            |
| APPLICATION                  |             |            |       | APPROVE  | DATE     | JRS       |               |
| ANGLES                       | FINISH      | ROUGH      | EDGE  | ME       | TRIC     |           |               |
| 0.X:±0.1                     |             | CHECK      | DATE  |          |          |           |               |
| ALL UNSPECIFIED CHAMFERS:0.2 |             | 0.XX:±0.05 | DEGR  | DATE     | 20140512 |           |               |